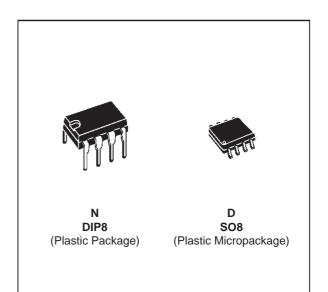


# **TSH31** 280MHz BANDWIDTH MOS INPUT SINGLE OPERATIONAL AMPLIFIER

- VERY LOW INPUT CURRENT : 2pA typ
- GAIN BANDWIDTH PRODUCT : 280MHz
- GAIN OF 2 STABILITY
- SLEW RATE : 300V/us
- STANDARD PIN OUT



#### DESCRIPTION

The TSH31 is a low cost wide bandwidth single operational amplifier featuring extremely low input current of 2pAtyp. Other features as high slew rate, fast settling time and high linearity make it suitable for many applications requiring speed and very high input impedance as photo cell amplifier, Fet probe, high speed precision integrator, sample and hold circuit...

#### **ORDER CODES**

Part	Temperature	Package			
Number	Range	N	N D		
TSH31I	-40°C, 125°C	•	•	SH31-	

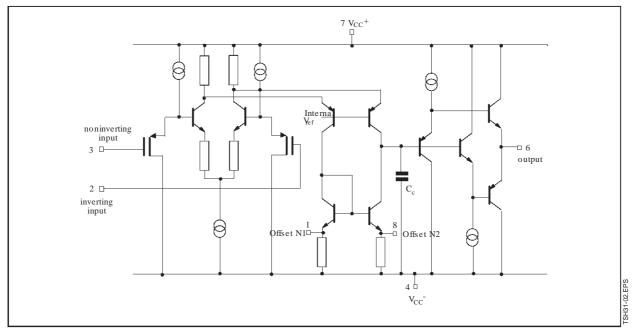
# **PIN CONNECTIONS** (top view) Offset Null 1 Offset Null 2 8 1 Inverting Input 2 7 $V_{CC}^+$ Non-inverting Input 3 6 Output 5 N.C. V<sub>CC</sub><sup>-</sup> 4

June 1998

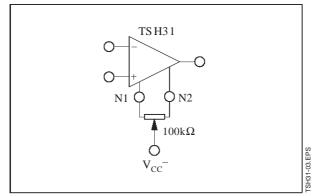
**ISH31-01.EPS** 

## TSH31

#### SCHEMATIC DIAGRAM



#### INPUT OFFSET VOLTAGE NULL CIRCUIT



#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
Vcc	Supply Voltage	±7	V
V <sub>id</sub>	Differential Input Voltage	±5	V
Vi	Input Voltage Range	± 5	V
l <sub>in</sub>	Current On Offset Null Pins	± 20	mA
T <sub>oper</sub>	Operating Free-Air Temperature Range TSH31C TSH311	0°C +70 -40°C +125	oC

## **OPERATING CONDITIONS**

Symbol	Parameter	Value	Unit
Vcc	Supply Voltage	$\pm$ 3 to $\pm$ 6	V
Vic	Common Mode Input Voltage Range	V <sub>CC</sub> <sup>-</sup> to V <sub>CC+</sub> -3	V

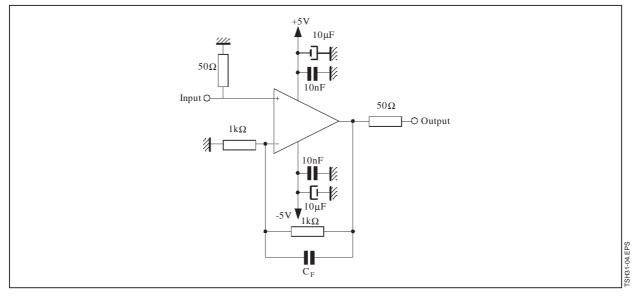


# ELECTRICAL CHARACTERISTICS

 $V_{CC} = \pm 5V$ ,  $T_{amb} = 25^{o}C$  (unless otherwise specified)

Symbol	Parameter		Min.	Тур.	Max.	Unit
Vio	Input Offset Voltage			3	15	mV
$DV_{io}$	Input Offset Voltage Drift $T_{min} \leq T_{amb} \leq T_{max}$			20		μV/ºC
l <sub>ib</sub>	Input Bias Current			2	300	рА
l <sub>io</sub>	Input Offset Current			2	200	рА
Icc	Supply Current, no load	$V_{CC} = \pm 5V$		20	40	mA
$A_{vd}$	Large Signal Voltage Gain $V_o = \pm 2.5 V$	R <sub>L</sub> = 100Ω	200	800		V/V
Vicm	Input Common Mode Voltage Rang	ge	-5 to +2	-5.5 to +2.5		V
CMR	Common Mode Rejection Ratio	Vic = Vicm min.	55	95		dB
SVR	Supply Voltage Rejection Ratio $V_{CC} = \pm 5V \text{ to } \pm 3V$		45	65		dB
Vo	Output Voltage	R <sub>L</sub> = 100Ω	± 2.5	+3.5 -3.7		V
Ι <sub>ο</sub>	Output Short Circuit Current $V_{id} = \pm 1V, V_0 = 0V$			±70		mA
GBP	Gain Bandwidth Product $A_{VCL} = 100$ , $R_L = 100\Omega$ , $f = 7.5I$	ИНz		280		MHz
SR	Slew Rate $V_{in} = \pm 2V$ , $A_{VCL} = 1$ , $R_L = 100\Omega$	2		300		V/µs
en	Equivalent Input Voltage Noise	f = 1MHz		20		$\frac{nV}{\sqrt{Hz}}$
Øm	Phase Margin $A_{VM} = 1, R_L = 100\Omega, C_L = 15pF$			40		Degrees

#### **EVALUATION CIRCUIT**



#### PRINTED CIRCUIT LAYOUT

As for any high frequency device, a few rules must be observed when designing the PCB to get the best performances from this high speed op amp.

From the most to the least important points :

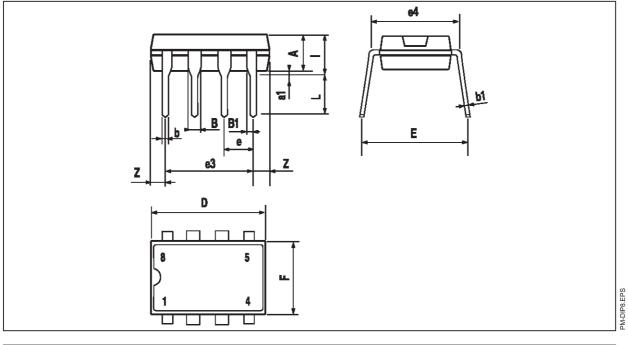
- Each power supply lead has to be bypassed to ground with a 10nF ceramic capacitor very close to the device and a 10µF tantalum capacitor.
- To provide low inductance and low resistance common return, use a ground plane or common point return for power and signal.
- All leads must be wide and as short as possible especially for op amp inputs. This is in order to decrease parasitic capacitance and

inductance.

- Use small resistor values to decrease time constant with parasitic capacitance.
- Choose component sizes as small as possible (SMD).
- On output, decrease capacitor load so as to avoid circuit stability being degraded which may cause oscillation. One can also add a serial resistor in order to minimise its influence.
- One can add in parallel with feedback resistor a few pF ceramic capacitor C<sub>F</sub> adjusted to optimize the settling time.

# PACKAGE MECHANICAL DATA 8 PINS - PLASTIC DIP

57

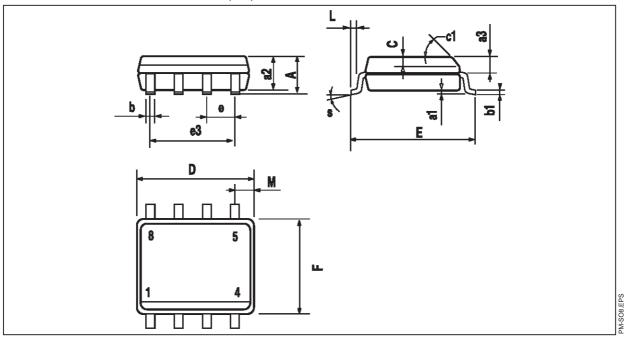


Dimensions		Millimeters			Inches	Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.		
A		3.32			0.131			
a1	0.51			0.020				
В	1.15		1.65	0.045		0.065		
b	0.356		0.55	0.014		0.022		
b1	0.204		0.304	0.008		0.012		
D			10.92			0.430		
E	7.95		9.75	0.313		0.384		
е		2.54			0.100			
e3		7.62			0.300			
e4		7.62			0.300			
F			6.6			0260		
i			5.08			0.200		
L	3.18		3.81	0.125		0.150	TBL	
Z			1.52			0.060	DIP8.TBL	

5/6

#### PACKAGE MECHANICAL DATA

8 PINS - PLASTIC MICROPACKAGE (SO)



Dimensions		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
A			1.75			0.069
a1	0.1		0.25	0.004		0.010
a2			1.65			0.065
a3	0.65		0.85	0.026		0.033
b	0.35		0.48	0.014		0.019
b1	0.19		0.25	0.007		0.010
С	0.25		0.5	0.010		0.020
c1		•	45°	(typ.)		
D	4.8		5.0	0.189		0.197
E	5.8		6.2	0.228		0.244
е		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.150		0.157
L	0.4		1.27	0.016		0.050
М			0.6			0.024
S	8° (max.)					

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57